

1 INTRODUCTION

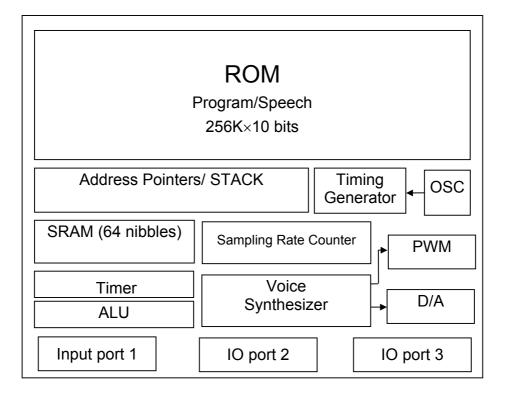
SNC10B is a one-channel voice synthesizer IC with PWM direct drive circuit. It built-in a 4-bit tiny controller with one 4-bit input port, two 4-bit I/O ports. By programming through the tiny controller in SNC10B, user's varied applications including voice section combination, key trigger arrangement, output control, and other logic functions can be easily implemented.

2 FEATURES

- Single power supply 2.4V 5.1V
- 85 seconds voice capacity are provided(@6KHZ sample rate)
- Built in a 4-bit tiny controller
- One 4-bit input port, two 4-bit I/O ports are provided
- 64*4 bits RAM are provided
- 256K*10 ROM size are provided for voice data and program
- Maximum 16k program ROM is provided
- Built in a high quality speech synthesizer
- Adaptive playing speed from 2.5k-20kHz is provided
- One voice channel
- Built in a PWM Direct Drive circuit and a fixed current D/A output
- System clock : 2MHz
- Low Power Reset



3 Block Diagram



4 PIN ASSIGNMENT

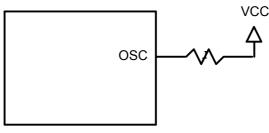
Symbol	I/O	Function Description				
P13 ~ P10		Bit3 ~ Bit0 of Input port 1				
P23 ~ P20	I/O	Bit3 ~ Bit0 of I/O port 2				
P33 ~ P30	I/O	Bit3 ~ Bit0 of I/O port 3				
VDD	Р	Positive power supply				
GND	Р	Negative power supply				
RST	Ι	Reset pin (active high)				
OSC	Ι	Oscillator Input				
BUO1/VO	0	Positive Output of PWM or DA output				
BUO2	0	Negative Output of PWM				



5 FUNCTION DESCRIPTIONS

5.1. Oscillator

SNC10B accepts RC type oscillator for system clock. The typical circuit diagram for oscillator is listed as follows.



RC Oscillator

5.2. ROM

SNC10B contains substantial 256K word (10-bit) internal ROM. Program, voices and other data are shared with this same 256K word ROM.

5.3. RAM

SNC10B contains 64 nibble RAM. The 64 nibble RAM is divided into four pages (page 0 to page 3, 16 nibble RAM on each page). In our programming structure, users can easily define and locate RAM page in the program. For instance, users can use the instructions, PAGEn (n=0 to 3) to switch and indicate the RAM page. Besides, users can use direct mode, M0 ~ M15 in the data transfer type instructions, to access all 16 nibbles of each page.

5.4. Power Down Mode

"End" instruction will power down SNC10B and enable IC to consume fewer current for power saving. (<3uA @VDD=3V and <5uA @VDD=5V) Please be aware that when the power down mode is activated in SNC10B, any valid data transition (L \rightarrow H or H \rightarrow L) occurring on any input port (P1) or IO ports (P2 and P3) will lead SNC10B back to normal operation mode.

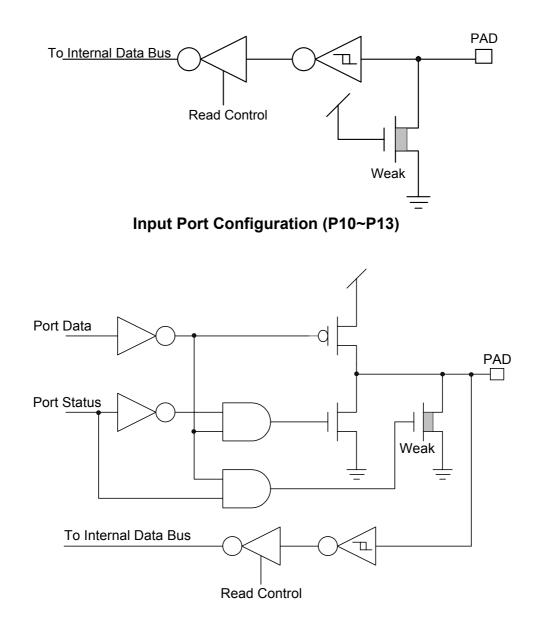
5.5. Sampling Rate Counter

The unique sampling rate counter is designed in voice channel to be able to play diverse voices at different sample playing rates. The playing rate can be adaptively set up among from the wide ranges of 2.5KHz to 20KHz. This feature makes voice close to its original source and yield the better voice quality.



5.6. I/O Ports

P1 is a 4-bit input port, P2 and P3 are two 4-bit I/O ports. Any bit of P2 and P3 can be programmed as either input or output port individually. Any valid data transition $(H \rightarrow L \text{ or } L \rightarrow H)$ of P1, P2 and P3 can reactivate the chip when the chip is in power-down mode.



I/O Port Configuration (P20~P23, P30~P33)

Note: All weak N-MOS's can serve as pull-low resistors.

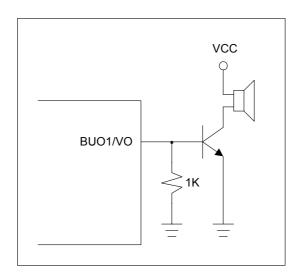


5.7. DAC & PWM

SNC10B is an advanced chip to be designed having two optimal methods to play out the voices. One is DAC and the other is PWM. Upon user's applications, user can select either DAC or PWM in his design. Please be aware that only one method can be activated at a time.

DAC: A 7-bit current type digital-to-analog converter is built-in SNC10B. The relationship between input digital data and output analog current signal is listed in the following table. Also, the recommended application circuit is illustrated as follows.

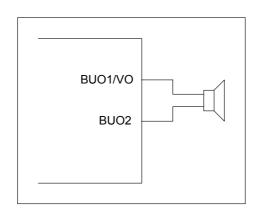
Input data	Typical value of output current (mA)
0	0
1	3/127
N	n*(3/127)
127	3



DAC output



PWM: A PWM (pulse width modulation) circuit is built-in SNC10B. PWM can convert input digital data into pulse trains with suitable different pulse width. The maximum resolution of PWM is 7 bits. Two huge output stage circuits are designed in SNC10B. With this advanced circuit, the chip is capable of driving speaker directly without external transistors. The recommended application circuit is illustrated as follows.



PWM Output



6 ABSOLUTE MAXIMUM RATING

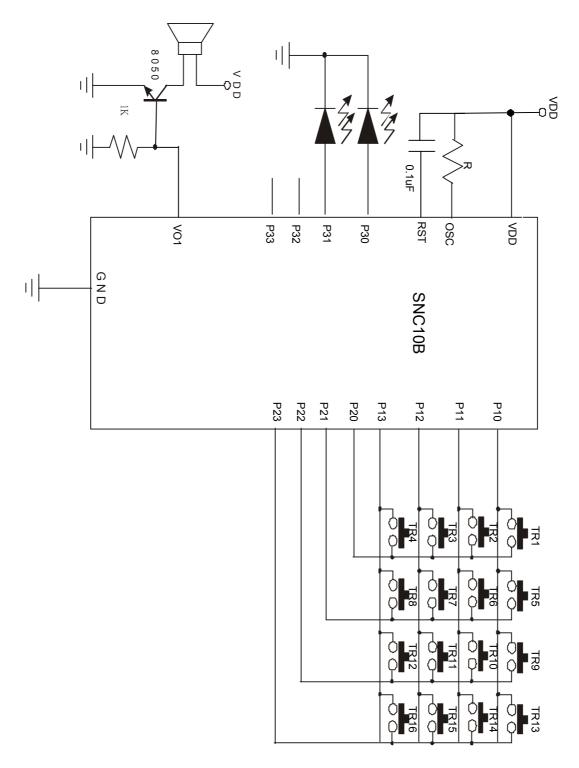
Items	Symbol	Min	Max	Unit.	
Supply Voltage	V_{DD} -V	-0.3	6.0	V	
Input Voltage	V _{IN}	V _{SS} -0.3	V _{DD} +0.3	V	
Operating Temperature	T _{OP}	0	55.0	°C	
Storage Temperature	T _{STG}	-55.0	125.0	°C	

7 ELECTRICAL CHARACTERISTICS

ltem	Sym.	Min.	Тур.	Max.	Unit	Condition
Operating Voltage	V_{DD}	2.4	3.0	5.1	V	
Standby current	I _{SBY}	-	-	3.0	иA	V _{DD} =3V, no load
Operating Current	I _{OPR}	-	-	250	иA	V _{DD} =3V, no load
Input current of	I _{IH}	-	3.0	10.0	uА	V _{DD} =3V,V _{IN} =3V
P1, P2, P3						
Drive current of	I _{OD}	-	4	-	mА	V _{DD} =3V,V _O =2.4V
P2, P3						
Sink Current of	los	-	6	-	mА	V _{DD} =3V,V _O =0.4V
P2, P3						
Drive current of Buo1	I _{OD}	100	120	-	mА	VDD=3V,Buo1=1.5V
Sink Current of Buo1	los	100	120	-	mА	VDD=3V,Buo1=1.5V
Drive Current of Buo2	I _{OD}	100	120	-	mА	VDD=3V,Buo2=1.5V
Sink Current of Buo2	los	100	120	-	mА	VDD=3V,Buo2=1.5V
Oscillation Freq.	Fosc	-	2.0	-	MHz	V _{DD} =3V



8 APPLICATION CIRCUIT



D/A Speaker Output 16 Scan Keys



								33	NC
								32	NC
								31	NC
								30	NC
								29	NC
								28	NC
								27	NC
								26	NC
								25	NC
								24	NC
								23	VDD
								22	GND
					(0.00,0.00)			21	NC
								20	NC
								19	P33
								18	P32
								17	P31
								16	P30
								15	P23
								14	P22
								13	P21
P10	1								
P11	2								
P12	3								
P13	4	6	7			10	1 1	12	RST
P20	5	6	′	8	9	10	11		
		0	2	В	<	В	G		
		OSC		BUO1	VDD	BUO2	GND		
)1	0)2	$\overline{}$		

Note: The substrate MUST be connected to Vss in PCB layout.



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